

# **HVL368CM**

# Variable Capacitance Diode for VCO

REJ03G0227-0200 Rev.2.00 Mar 10, 2006

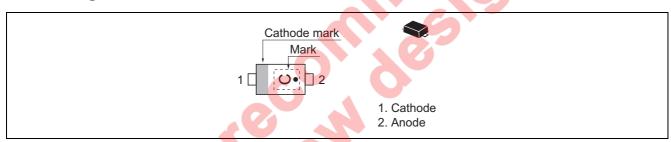
### **Features**

- Narrow terminal Capacitance deviation.
- Low series resistance. ( $r_s = 1.1 \Omega \text{ max}$ )
- Good C-V linearity.
- Thin Extremely small Flat Lead Package (TEFP) is suitable for surface mount design.

# **Ordering Information**

Type No.	Laser Mark	Package Name	Package Code	
HVL368CM	С	TEFP	PUSF0002ZA-A	

# **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Reverse voltage	V <sub>R</sub>	10	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I <sub>R1</sub>	_	_	10	nA	V <sub>R</sub> = 10 V
	I <sub>R2</sub>	_	_	100		V <sub>R</sub> = 10 V, Ta = 60°C
Capacitance	C <sub>1</sub>	15.0	_	16.5	pF	$V_R = 1 \text{ V}, f = 1 \text{ MHz}$
	C <sub>2</sub>	9.0		10.2		$V_R = 2 \text{ V}, f = 1 \text{ MHz}$
	C <sub>3</sub>	5.0	_	6.0		$V_R = 3 \text{ V}, f = 1 \text{ MHz}$
Capacitance ratio	n	2.2	_	_	1	C <sub>1</sub> / C <sub>3</sub>
Series resistance	r <sub>S</sub>	_	_	1.1	Ω	V <sub>R</sub> = 2 V, f = 470 MHz

Note: For TEFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.



## **Main Characteristic**

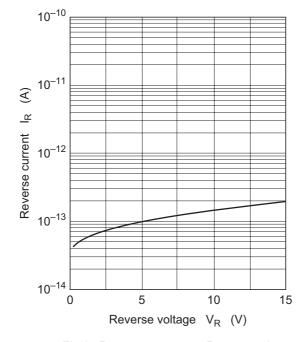


Fig.1 Reverse current vs. Reverse voltage

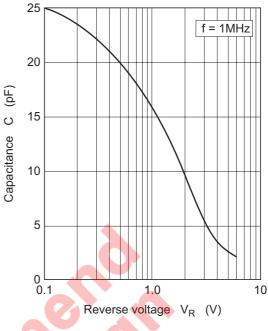
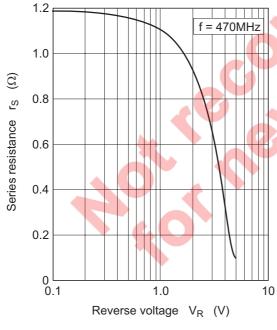
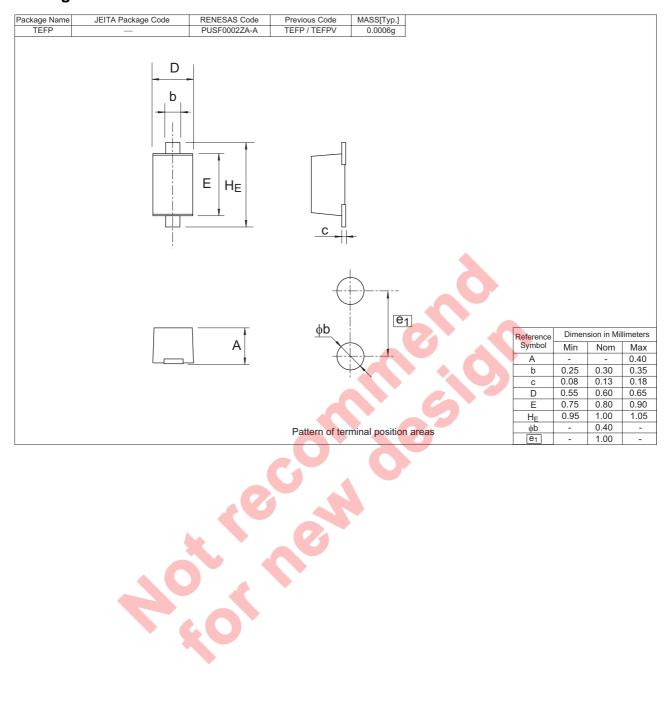
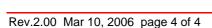


Fig.2 Capacitance vs. Reverse voltage



## **Package Dimensions**





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